

### FEATURES

- Sixth-order filters
- Transparent input sync tip clamp
- 1 dB bandwidth of 26 MHz typical for HD
- HD rejection @ 75 MHz: 48 dB typical
- NTSC differential gain: 0.19%
- NTSC differential phase: 0.76°
- Rail-to-rail outputs
- Low quiescent current: 32 mA typical
- Disable feature
- Output dc offset

### APPLICATIONS

- Set-top boxes
- DVD players and recorders
- HDTVs
- Projectors
- Personal video recorders

### GENERAL DESCRIPTION

The ADA4420-6 is a low cost video reconstruction filter specifically designed for consumer applications. It consists of six independent sixth-order Butterworth filters/buffers, three for standard definition (Y/C or CVBS) and three for high definition component signals (YPrPb or RGB).

The ADA4420-6 operates from a single 5 V supply and has a low quiescent current of 32 mA, making it ideal for applications where power consumption is critical. A disable feature allows for further power conservation by reducing the supply current to less than 8  $\mu$ A typical when the device is not in use.

### FUNCTIONAL BLOCK DIAGRAM

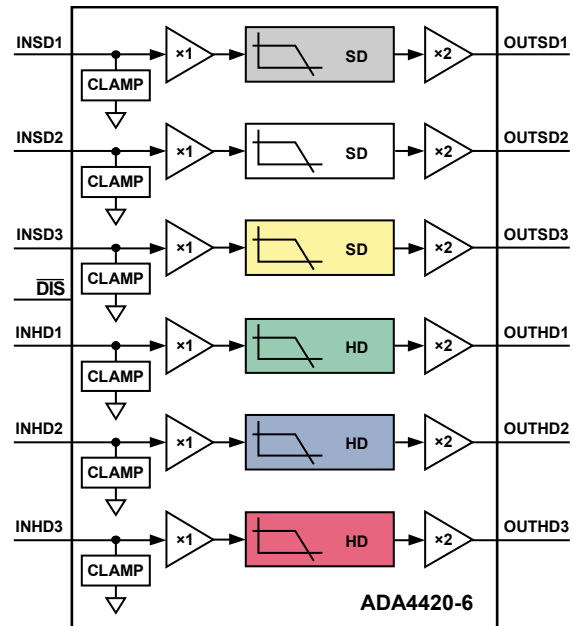


Figure 1.

Each channel features a transparent sync tip clamp, allowing a coupling of the inputs without requiring dc restoration.

The output drivers on the ADA4420-6 have rail-to-rail output capabilities with 6 dB gain. A built-in offset of 250 mV allows the outputs to be dc-coupled, eliminating the need for large coupling capacitors. Each output is capable of driving two 75  $\Omega$  doubly terminated cables.

The ADA4420-6 is available in either a 16-lead QSOP or a 20-lead TSSOP, and operates in the extended industrial temperature range of -40°C to +85°C.

#### Rev. A

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

## TABLE OF CONTENTS

|  |   |   |    |
|--|---|---|----|
| Features .....                                   | 1 | Typical Performance Characteristics ..... | 7  |
| Applications.....                                | 1 | Test Circuits.....                        | 10 |
| General Description .....                        | 1 | Applications Information .....            | 11 |
| Functional Block Diagram .....                   | 1 | Overview .....                            | 11 |
| Revision History .....                           | 2 | Disable .....                             | 11 |
| Specifications.....                              | 3 | Input and Output Coupling.....            | 11 |
| Absolute Maximum Ratings.....                    | 4 | Printed Circuit Board (PCB) Layout .....  | 11 |
| Thermal Resistance .....                         | 4 | Video Encoder Reconstruction Filter ..... | 11 |
| Maximum Power Dissipation .....                  | 4 | Outline Dimensions .....                  | 13 |
| ESD Caution.....                                 | 4 | Ordering Guide .....                      | 14 |
| Pin Configuration and Function Descriptions..... | 5 |   |    |

## REVISION HISTORY

### 5/11—Rev. 0 to Rev. A

|   |           |
|---|-----------|
| Added 20-Lead TSSOP Package .....   | Universal |
| Changes to General Description Section .....  | 1         |
| Changes to Disable Assert Voltage, Disable Assert Time, Disable De-Assert Time Parameters ..... | 3         |
| Changes to Table 3, Maximum Power Dissipation Section, and Figure 2 .....                       | 4         |
| Added Figure 4 and Table 5.....   | 6         |
| Changes to Figure 18, Figure 19, and Figure 20 .....  | 10        |
| Updated Outline Dimensions .....  | 13        |
| Changes to Ordering Guide .....   | 14        |

### 8/08—Revision 0: Initial Version

## SPECIFICATIONS

$V_S = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $V_O = 2.0\text{ V p-p}$ ,  $R_L = 150\ \Omega$ , dc-coupled inputs, ac-coupled outputs, unless otherwise noted. See Figure 18, Figure 19, and Figure 20 for the test circuits.

Table 1.

| Parameter                             | Test Conditions/Comments  | Min | Typ          | Max | Unit          |
|---------------------------------------|---|-----|--------------|-----|---------------|
| <b>OVERALL PERFORMANCE</b>            |   |     |              |     |               |
| DC Voltage Gain                       | All channels  | 5.8 | 6.0          | 6.2 | dB            |
| Input Voltage Range, All Inputs       |   |     | 0 to 2.1     |     | V             |
| Output Voltage Range, All Outputs     |   |     | 0.25 to 4.6  |     | V             |
| Linear Output Current per Channel     |   |     | 30           |     | mA            |
| Filter Input Bias Current             |   |     | 1            |     | $\mu\text{A}$ |
| <b>SD CHANNEL DYNAMIC PERFORMANCE</b> |   |     |              |     |               |
| -1 dB Bandwidth                       |   |     | 8.6          |     | MHz           |
| -3 dB Bandwidth                       |   | 8.5 | 10           |     | MHz           |
| Out-of-Band Rejection                 | $f = 27\text{ MHz}$   | 42  | 45           |     | dB            |
| Crosstalk                             | $f = 1\text{ MHz}$  |     | -68          |     | dB            |
| Total Harmonic Distortion             | $f = 1\text{ MHz}$ , $V_O = 1.4\text{ V p-p}$ , dc-coupled outputs  |     | 0.02         |     | %             |
| Signal-to-Noise Ratio                 | $f = 100\text{ kHz to }6\text{ MHz}$ , unweighted                   |     | 70           |     | dB            |
| Propagation Delay                     |   |     | 57           |     | ns            |
| Group Delay Variation                 | $f = 100\text{ kHz to }5\text{ MHz}$                                |     | 16           |     | ns            |
| Differential Gain                     | NTSC; ac-coupled inputs, dc-coupled outputs; see Figure 19          |     | 0.19         |     | %             |
| Differential Phase                    | NTSC; ac-coupled inputs, dc-coupled outputs; see Figure 19          |     | 0.76         |     | Degrees       |
| <b>HD CHANNEL DYNAMIC PERFORMANCE</b> |   |     |              |     |               |
| -1 dB Bandwidth                       |   |     | 26           |     | MHz           |
| -3 dB Bandwidth                       |   | 27  | 31           |     | MHz           |
| Out-of-Band Rejection                 | $f = 75\text{ MHz}$   | 43  | 48           |     | dB            |
| Crosstalk                             | $f = 1\text{ MHz}$  |     | -68          |     | dB            |
| Total Harmonic Distortion             | $f = 10\text{ MHz}$ , $V_O = 1.4\text{ V p-p}$ , dc-coupled outputs |     | 0.57         |     | %             |
| Signal-to-Noise Ratio                 | $f = 100\text{ kHz to }30\text{ MHz}$ , unweighted                  |     | 66           |     | dB            |
| Propagation Delay                     |   |     | 15           |     | ns            |
| Group Delay Variation                 | $f = 100\text{ kHz to }30\text{ MHz}$                               |     | 11           |     | ns            |
| <b>DC CHARACTERISTICS</b>             |   |     |              |     |               |
| Operating Voltage                     |   |     | 4.75 to 5.25 |     | V             |
| Quiescent Supply Current              | Active, $\overline{\text{DIS}} = 1$                                 |     | 32           | 36  | mA            |
|                                       | Disabled, $\overline{\text{DIS}} = 0$                               |     | 7            | 13  | $\mu\text{A}$ |
| PSRR                                  | HD channel, referred to output                                      | 35  | 41           |     | dB            |
|                                       | SD channel, referred to output                                      | 40  | 45           |     | dB            |
| Output DC Offset                      | All channels  | 135 | 250          | 375 | mV            |
| Disable Assert Voltage                | $\overline{\text{DIS}} = 0$ to 1                                    |     |              | 1.9 | V             |
| Disable Assert Time                   | $\overline{\text{DIS}} = 0$ to 1                                    |     | 20           |     | ns            |
| Disable De-Assert Time                | $\overline{\text{DIS}} = 1$ to 0                                    |     | 450          |     | ns            |
| Disable Input Bias Current            | Disabled, $\overline{\text{DIS}} = 0$                               |     | -6.8         |     | $\mu\text{A}$ |
| Input-to-Output Isolation             | Disabled, $\overline{\text{DIS}} = 0$ , $f = 5\text{ MHz}$          |     | -96          |     | dB            |

## ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter                            | Rating          |
|--------------------------------------|-----------------|
| Supply Voltage                       | 5.5 V           |
| Power Dissipation                    | See Figure 2    |
| Storage Temperature Range            | -65°C to +125°C |
| Operating Temperature Range          | -40°C to +85°C  |
| Lead Temperature (Soldering, 10 sec) | 300°C           |
| Junction Temperature                 | 150°C           |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### THERMAL RESISTANCE

$\theta_{JA}$  is specified for the device soldered to a high thermal conductivity 4-layer (2s2p) circuit board, as described in EIA/JESD 51-7.

Table 3.

| Package Type  | $\theta_{JA}$ | $\theta_{JC}$ | Unit |
|---------------|---------------|---------------|------|
| 16-Lead QSOP  | 105           | 23            | °C/W |
| 20-Lead TSSOP | 143           | 45            | °C/W |

### MAXIMUM POWER DISSIPATION

The maximum safe power dissipation in the ADA4420-6 package is limited by the associated rise in junction temperature ( $T_J$ ) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance of the ADA4420-6. Exceeding a junction temperature of 150°C for an extended time can result in changes in the silicon devices, potentially causing failure.

The power dissipated in the package ( $P_D$ ) is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive for all outputs. The quiescent power is the voltage between the supply pins ( $V_S$ ) times the quiescent current ( $I_S$ ). The power dissipated due to load drive depends on the particular application. For each output, the power due to load drive is calculated by multiplying the load current by the associated voltage drop across the device. The power dissipated due to the loads is equal to the sum of the power dissipations due to each individual load. RMS voltages and currents must be used in these calculations.

Airflow increases heat dissipation, effectively reducing  $\theta_{JA}$ . Figure 2 shows the maximum power dissipation in the package vs. the ambient temperature for the 16-lead QSOP (105°C/W) and the 20-lead TSSOP (143°C/W) on a JEDEC standard 4-layer board.  $\theta_{JA}$  values are approximate.

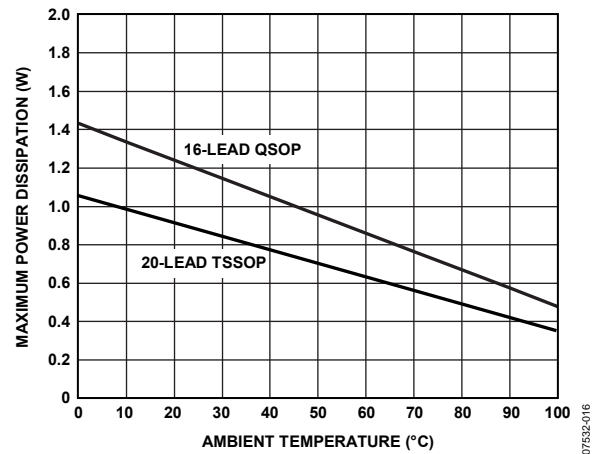


Figure 2. Maximum Power Dissipation vs. Ambient Temperature for a 4-Layer Board

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

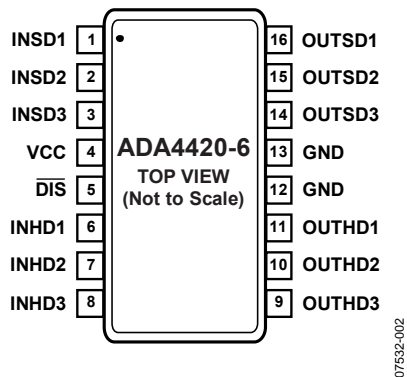
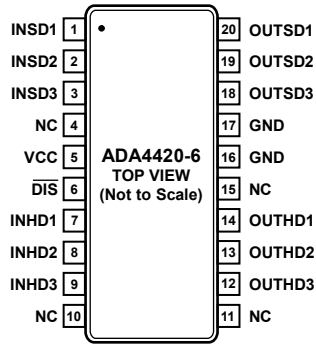


Figure 3. 16-Lead QSOP Pin Configuration

Table 4. 16-Pin QSOP Pin Function Descriptions

| Pin No. | Mnemonic                | Description                  |
|---------|-------------------------|------------------------------|
| 1       | INSD1                   | Standard Definition Input 1  |
| 2       | INSD2                   | Standard Definition Input 2  |
| 3       | INSD3                   | Standard Definition Input 3  |
| 4       | VCC                     | Power Supply                 |
| 5       | $\overline{\text{DIS}}$ | Disable/Power-Down Input     |
| 6       | INHD1                   | High Definition Input 1      |
| 7       | INHD2                   | High Definition Input 2      |
| 8       | INHD3                   | High Definition Input 3      |
| 9       | OUTHD3                  | High Definition Output 3     |
| 10      | OUTHD2                  | High Definition Output 2     |
| 11      | OUTHD1                  | High Definition Output 1     |
| 12      | GND                     | Ground                       |
| 13      | GND                     | Ground                       |
| 14      | OUTSD3                  | Standard Definition Output 3 |
| 15      | OUTSD2                  | Standard Definition Output 2 |
| 16      | OUTSD1                  | Standard Definition Output 1 |

# ADA4420-6



NC = NO CONNECT.  
DO NOT CONNECT TO THIS PIN.

07532-003

Figure 4. 20-Lead TSSOP Pin Configuration

Table 5. 20-lead TSSOP Pin Function Descriptions

| Pin No. | Mnemonic                | Description                   |
|---------|-------------------------|-------------------------------|
| 1       | INSD1                   | Standard Definition Input 1.  |
| 2       | INSD2                   | Standard Definition Input 2.  |
| 3       | INSD3                   | Standard Definition Input 3.  |
| 4       | NC                      | Do not connect to this pin.   |
| 5       | VCC                     | Power Supply.                 |
| 6       | $\overline{\text{DIS}}$ | Disable/Power Down Input.     |
| 7       | INHD1                   | High Definition Input 1.      |
| 8       | INHD2                   | High Definition Input 2.      |
| 9       | INHD3                   | High Definition Input 3.      |
| 10      | NC                      | Do not connect to this pin.   |
| 11      | NC                      | Do not connect to this pin.   |
| 12      | OUTHD3                  | High Definition Output 3.     |
| 13      | OUTHD2                  | High Definition Output 2.     |
| 14      | OUTHD1                  | High Definition Output 1.     |
| 15      | NC                      | No Connection.                |
| 16      | GND                     | Ground.                       |
| 17      | GND                     | Ground.                       |
| 18      | OUTSD3                  | Standard Definition Output 3. |
| 19      | OUTSD2                  | Standard Definition Output 2. |
| 20      | OUTSD1                  | Standard Definition Output 1. |

# TYPICAL PERFORMANCE CHARACTERISTICS

$V_S = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $V_O = 2.0\text{ V p-p}$ ,  $R_L = 150\ \Omega$ , dc-coupled inputs, ac-coupled outputs, unless otherwise noted. See Figure 18, Figure 19, and Figure 20 for the test circuits.

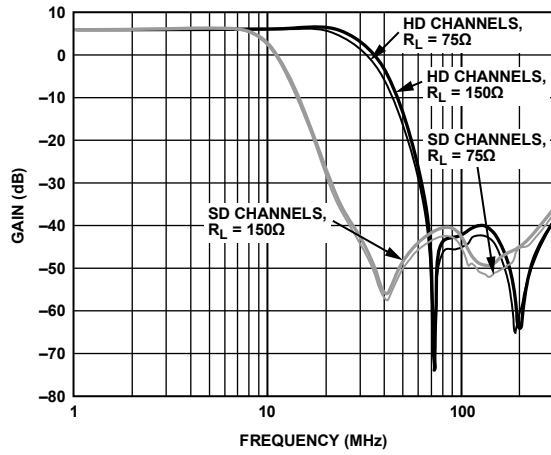


Figure 5. Frequency Response vs. Load ( $R_L$ )

07532-004

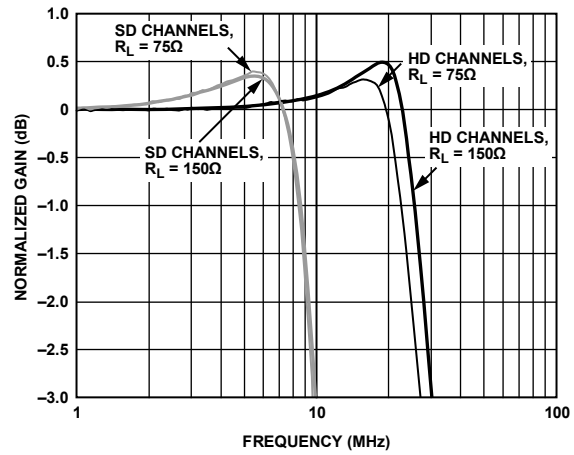


Figure 8. Flatness vs. Load ( $R_L$ )

07532-007

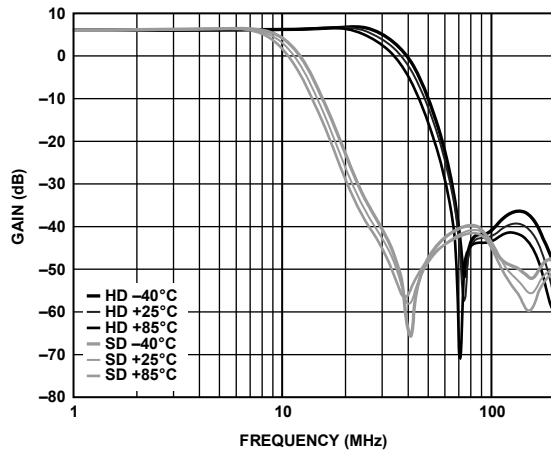


Figure 6. Frequency Response vs. Temperature

07532-005

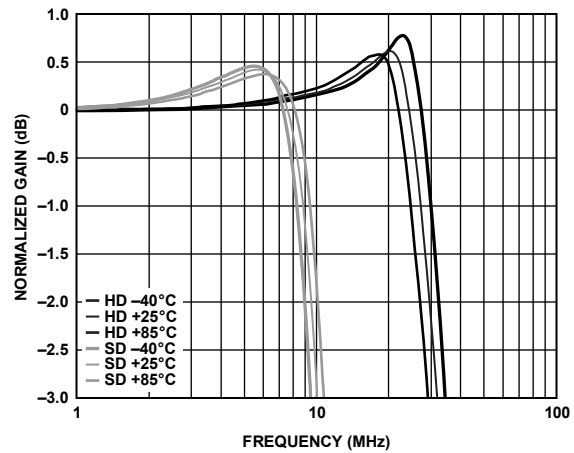


Figure 9. Flatness vs. Temperature

07532-008

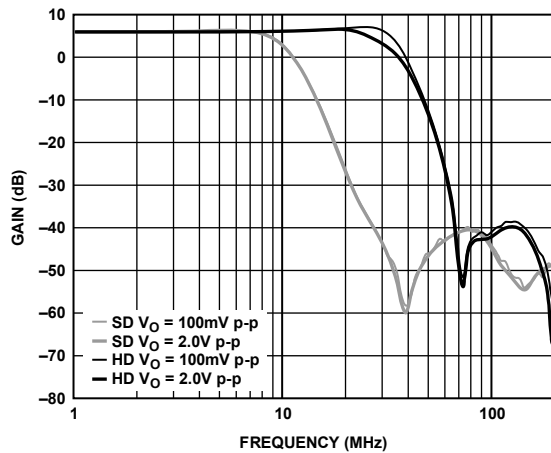


Figure 7. Frequency Response vs. Amplitude

07532-006

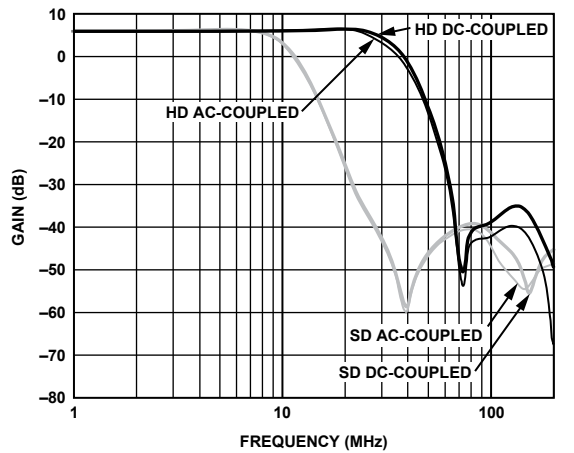


Figure 10. Frequency Response vs. Output Coupling

07532-017

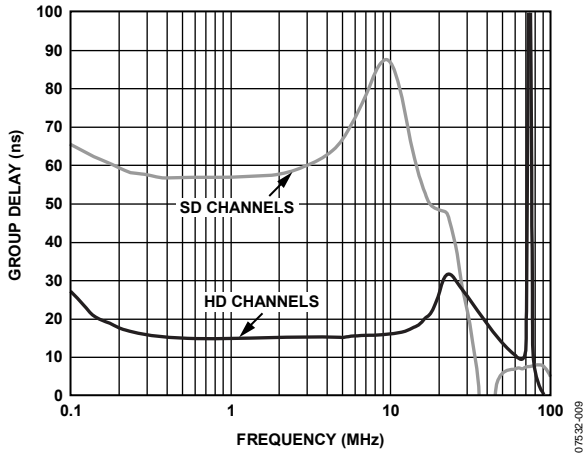


Figure 11. Group Delay vs. Frequency

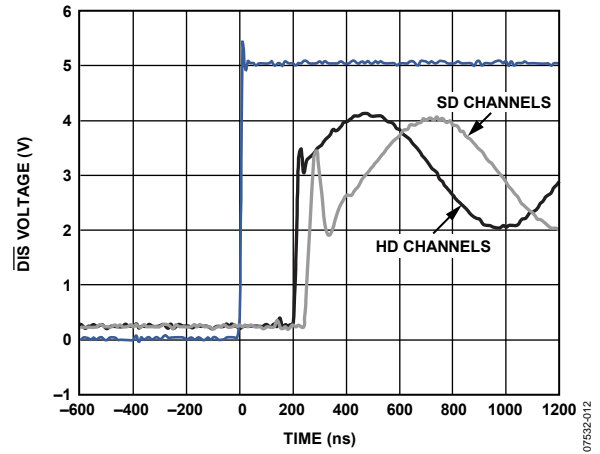


Figure 13. Enable Time

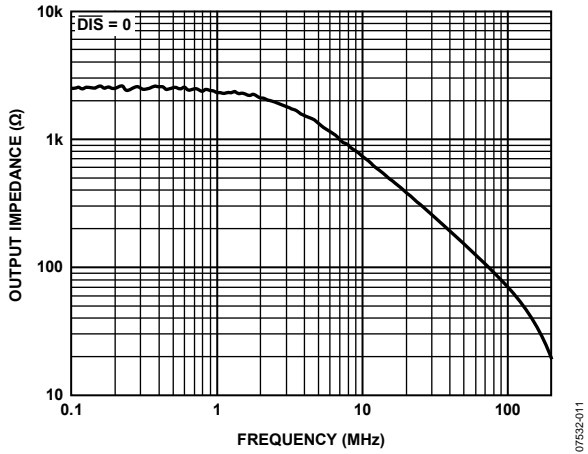


Figure 12. Output Impedance vs. Frequency

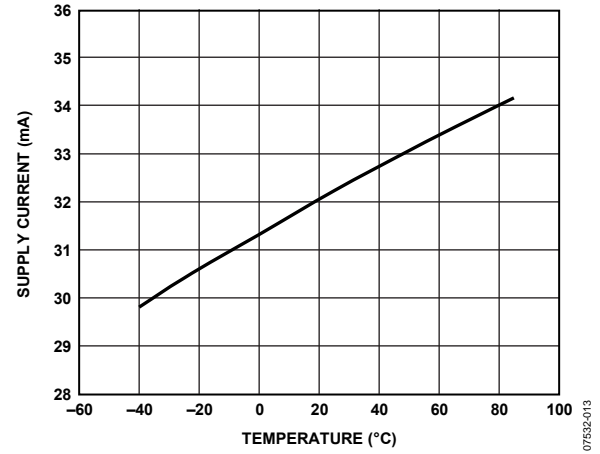


Figure 14. Supply Current vs. Temperature



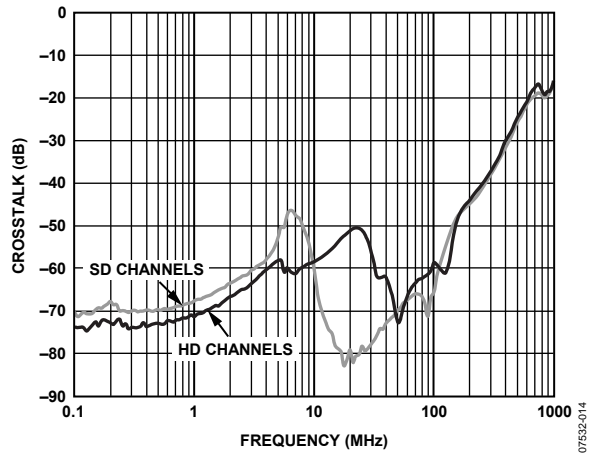


Figure 15. Crosstalk vs. Frequency

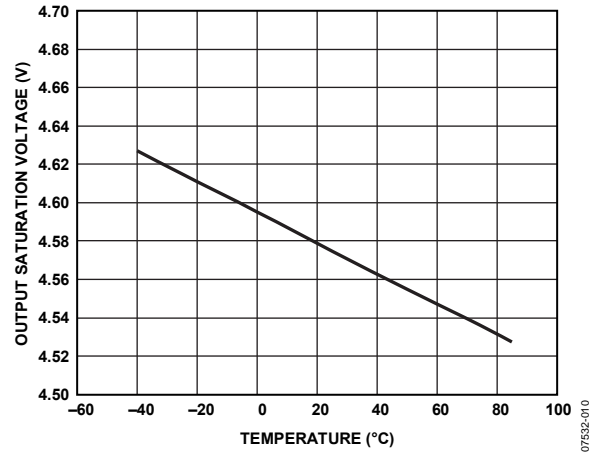


Figure 17. Output Saturation Voltage vs. Temperature

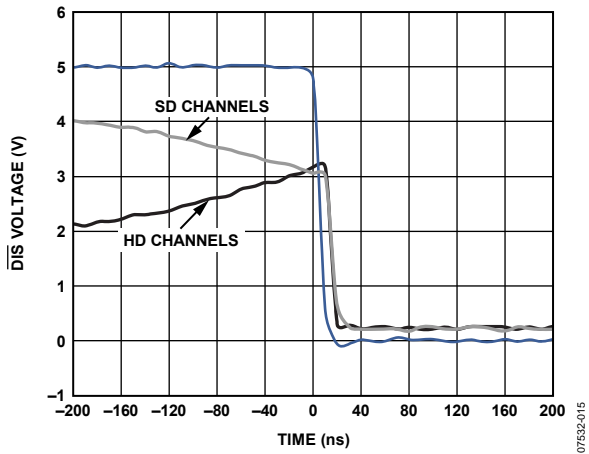


Figure 16. Disable Time

## TEST CIRCUITS

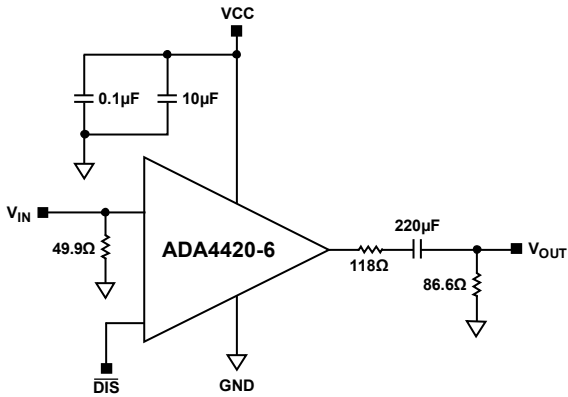


Figure 18. DC-Coupled Input, AC-Coupled Output

07532-018

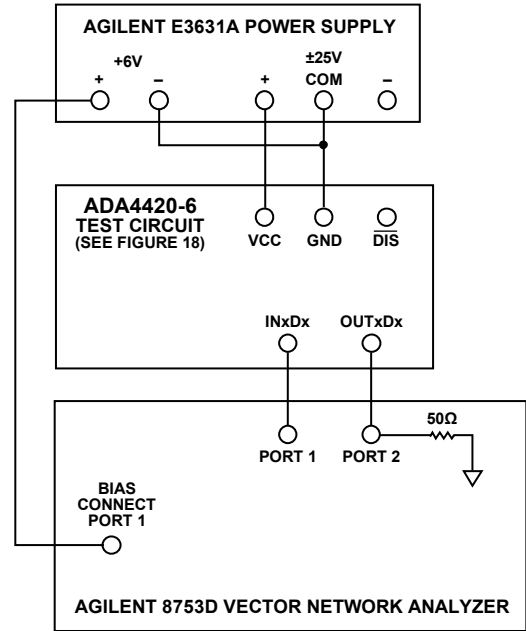


Figure 20. Test Circuit for Frequency Response and Group Delay

07532-020

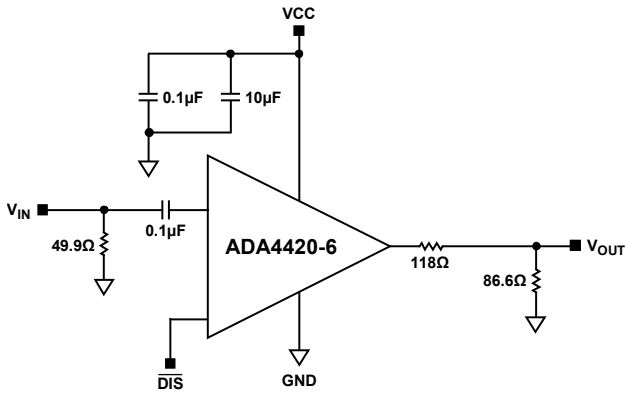


Figure 19. AC-Coupled Input, DC-Coupled Output

07532-019

## APPLICATIONS INFORMATION

### OVERVIEW

With its high impedance inputs and high output drive, the ADA4420-6 is ideally suited to video reconstruction and anti-alias filtering applications. The high impedance inputs give designers flexibility with regard to how the input signals are terminated. Devices with DAC current source outputs that feed the ADA4420-6 can be loaded in whatever resistance provides the best performance, and devices with voltage outputs can be optimally terminated as well. The ADA4420-6 outputs can each drive up to two source-terminated, 75 Ω loads and; therefore, can directly drive the outputs from set-top boxes and DVDs without the need for a separate output buffer.

### DISABLE

The ADA4420-6 includes a disable feature that can be used to save power when a particular device is not in use. When disabled, the ADA4420-6 typically draws only 7 μA from the supply. The disable feature is asserted by pulling the  $\overline{\text{DIS}}$  pin low.

Table 6 summarizes the operation of the disable feature.

Table 6. Disable Function

| DIS Pin Connection          | Status   |
|-----------------------------|----------|
| V <sub>CC</sub> or Floating | Enabled  |
| GND                         | Disabled |

### INPUT AND OUTPUT COUPLING

Inputs to the ADA4420-6 can be ac- or dc-coupled. For dc-coupled inputs, the signal must be completely contained within the input range of 0 V to 2.1 V. When using ac-coupled inputs, the lowest point of the signal is clamped to approximately 0 V. The ADA4420-6 outputs can be either ac- or dc-coupled.

When driving single ac-coupled loads in standard 75 Ω video distribution systems, a minimum capacitance of 220 μF is recommended to avoid line and field droop. There are two ac coupling options when driving two loads from one output. One option simply uses the same value capacitor on the second load, while the other option uses a common coupling capacitor that is at least twice the value used for the single load (see Figure 21 and Figure 22).

When driving two parallel 150 Ω loads (75 Ω effective load), the 3 dB bandwidth of the filters typically varies from that of the filters with a single 150 Ω load (see Figure 5).

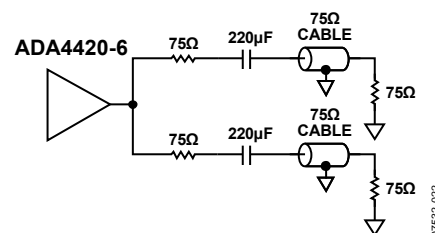


Figure 21. Driving Two AC-Coupled Loads with Two Coupling Capacitors

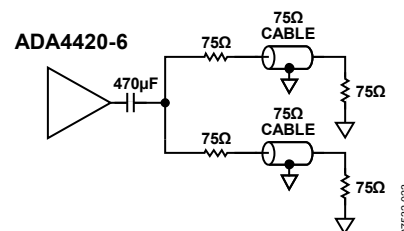


Figure 22. Driving Two AC-Coupled Loads with One Common Coupling Capacitor

### PRINTED CIRCUIT BOARD (PCB) LAYOUT

As with all high speed applications, attention to the PCB layout is of paramount importance. When designing with the ADA4420-6, adhere to standard high speed layout practices. A solid ground plane is recommended, and surface-mount, ceramic power supply decoupling capacitors should be placed as close as possible to the supply pins. Connect all of the ADA4420-6 GND pins to the ground plane with traces that are as short as possible. Controlled impedance traces of the shortest length possible should be used to connect to the signal I/O pins and should not pass over any voids in the ground plane. A 75 Ω impedance level is typically used in video applications. When driving transmission lines, include series termination resistors on the signal outputs of the ADA4420-6.

When the ADA4420-6 receives its inputs from a device with current outputs, the required load resistor value for the output current is often different from the characteristic impedance of the signal traces. In this case, if the interconnections are short ( $\ll 0.1$  wavelength), the trace does not have to be terminated in its characteristic impedance. Traces of 75 Ω can be used in this instance, provided their lengths are an inch or two at most. This is easily achieved because the ADA4420-6 and the device feeding it are usually adjacent to each other, and connections can be made that are less than one inch in length.

### VIDEO ENCODER RECONSTRUCTION FILTER

The ADA4420-6 is easily applied as a reconstruction filter at the DAC outputs of a video encoder. Figure 23 illustrates how to use the ADA4420-6 in this type of application following an ADV734x series video encoder, with a single-supply and ac-coupled outputs.

# ADA4420-6

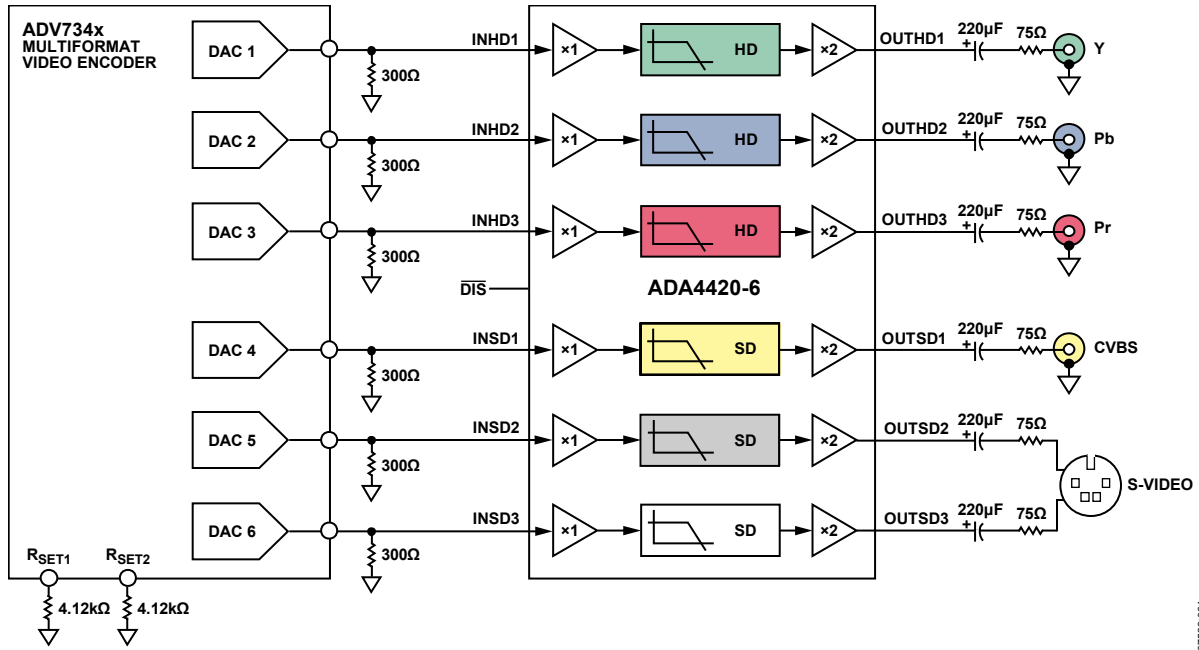
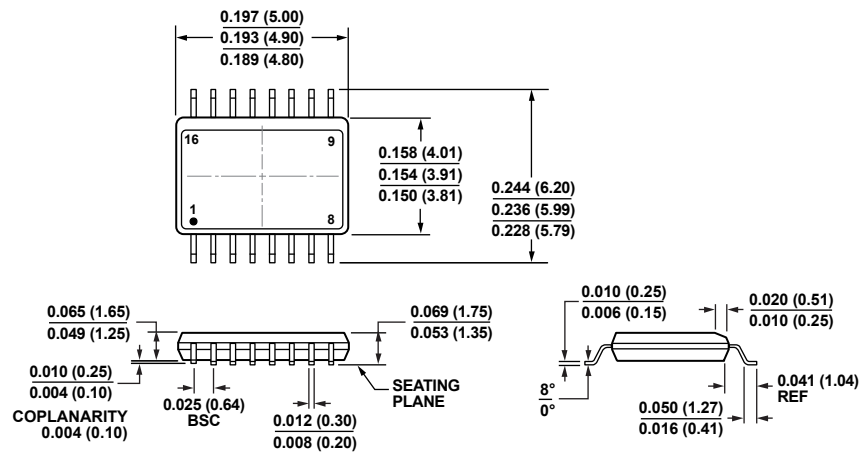


Figure 23. The ADA4420-6 Applied as a Reconstruction Filter Following an ADV734x Series Video Encoder

07532-021

# OUTLINE DIMENSIONS

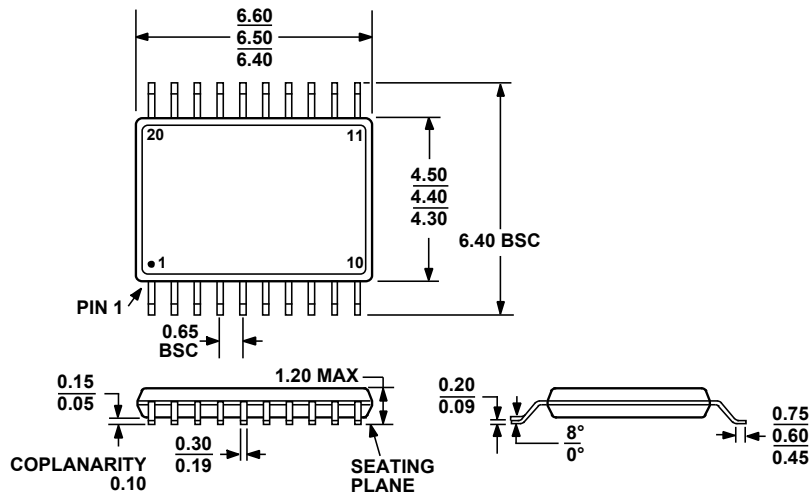


COMPLIANT TO JEDEC STANDARDS MO-137-AB  
 CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS  
 (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR  
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 24. 16-Lead Shrink Small Outline Package [QSOP] (RQ-16)

Dimensions shown in inches and (millimeters)

01-28-2008-A



COMPLIANT TO JEDEC STANDARDS MO-153-AC

Figure 25. 20-Lead Thin Shrink Small Outline Package [TSSOP] (RU-20)

Dimensions shown in millimeters

# ADA4420-6

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                               | Package Option | Ordering Quantity |
|--------------------|-------------------|---|----------------|-------------------|
| ADA4420-6ARQZ      | -40°C to +85°C    | 16-Lead Shrink Small Outline Package (QSOP)       | RQ-16          | Tube (98)         |
| ADA4420-6ARQZ-R7   | -40°C to +85°C    | 16-Lead Shrink Small Outline Package (QSOP)       | RQ-16          | 1,000             |
| ADA4420-6ARQZ-RL   | -40°C to +85°C    | 16-Lead Shrink Small Outline Package (QSOP)       | RQ-16          | 2,500             |
| ADA4420-6ARUZ      | -40°C to +85°C    | 20-Lead Thin Shrink Small Outline Package (TSSOP) | RU-20          | Tube (75)         |
| ADA4420-6ARUZ-R7   | -40°C to +85°C    | 20-Lead Thin Shrink Small Outline Package (TSSOP) | RU-20          | 1,000             |
| ADA4420-6ARUZ-RL   | -40°C to +85°C    | 20-Lead Thin Shrink Small Outline Package (TSSOP) | RU-20          | 2,500             |

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**

**NOTES**



Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкуренспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)